



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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2.0A SURFACE MOUNT FAST GLASS PASSIVATED BRIDGE RECTIFIER
Product Summary (@T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _F (V)	I _R (μA)
200, 400, 600, 800, 1000	2.0	1.3	5

Description and Applications

Suitable for AC to DC bridge full wave rectification for SMPS, LED lighting, adapter, battery charger, home appliances, office equipment, and telecommunication applications.

Features and Benefits

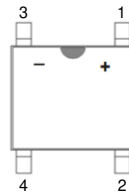
- Glass Passivated Die Construction
- Miniature Surface Mount Package Saves Space on PC Boards
- High Current Capability
- Fast Reverse Recovery Time Suitable for High Frequency Applications
- Low Forward Voltage Drop
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

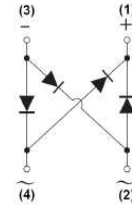
- Case: SOPA-4 (Type B)
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 @3
- Polarity: As marked on Body
- Weight: 0.089 grams (Approximate)



Top View



Pin Diagram

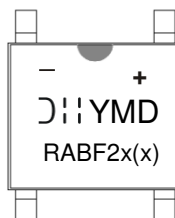


Internal Schematic

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
RABF210-13	Commercial	SOPA-4 (Type B)	5,000/Tape & Reel
RABF28-13	Commercial	SOPA-4 (Type B)	5,000/Tape & Reel
RABF26-13	Commercial	SOPA-4 (Type B)	5,000/Tape & Reel
RABF24-13	Commercial	SOPA-4 (Type B)	5,000/Tape & Reel
RABF22-13	Commercial	SOPA-4 (Type B)	5,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information


RABF2x(x) = Product Type Marking Code
 D11 = Manufacturers' Code Marking
 YMD = Date Code Marking
 Y = Last Digit of Year (ex: 8 = 2018)
 M = See Month/Code Table Below
 D = Day 1 to 9 = 1 to 9; Day 10 to 31 = A to V

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings and Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	RABF22	RABF24	RABF26	RABF28	RABF210	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	400	600	800	1000	V
RMS Reverse Voltage	V _{R(RMS)}	140	280	420	560	700	V
Average Rectified Output Current (Note 5) @ T _C = +100°C	I _O	2.0					A
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	60					A
I ² t Rating for Fusing (1ms < t < 8.3ms)	I ² t	14.94					A ² S
Maximum Forward Voltage (Per Element) @ I _F = 2.0A	V _{FM}	1.3					V
Maximum Reverse Recovery Time (Note 6)	t _{RR}	150		250	500		ns
Peak Reverse Current @ T _A = +25°C At Rated DC Blocking Voltage (Note 7) @ T _A = +125°C	I _R	5.0 200					μA
Typical Total Capacitance (Per Element) (Note 8)	C _T	17					ns

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 5) (Per Element)	R _{θJA}	63	°C/W
Typical Thermal Resistance, Junction to Lead (Per Element)	R _{θJL}	25	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

- Notes:
- Device mounted on aluminum substrate PC board with 1.3mm² solder pad.
 - Reverse Recovery Test Conditions: I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A.
 - Short duration pulse test used to minimize self-heating effect.
 - Measured at 1.0MHz and applied reverse voltage of 4.0V D.C.

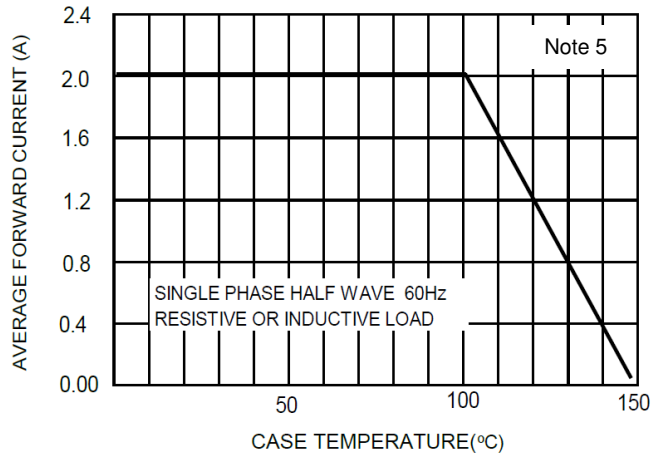


Figure1. Forward Current Derating

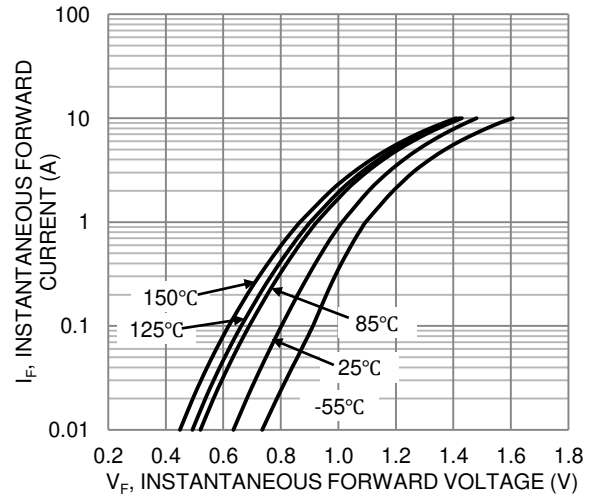


Figure 2. Typical Forward Characteristics

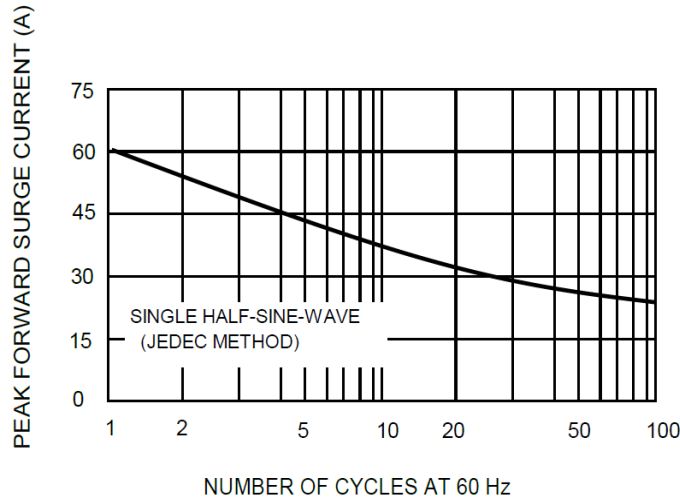


Figure 3. Maximum Non-Repetitive Forward Surge Current

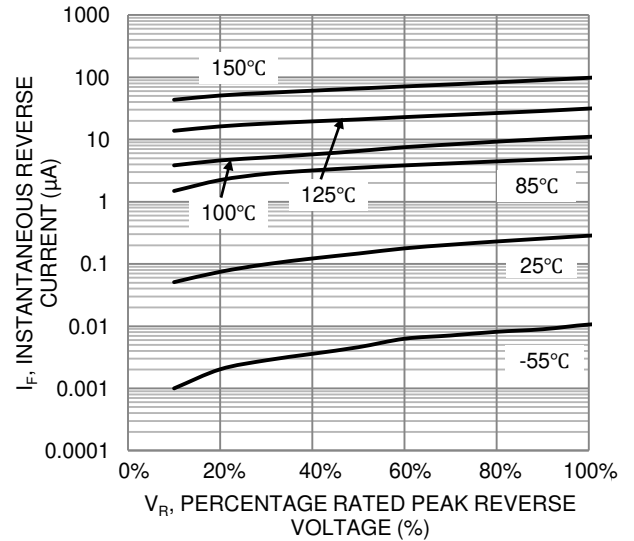


Figure 4. Typical Reverse Characteristics

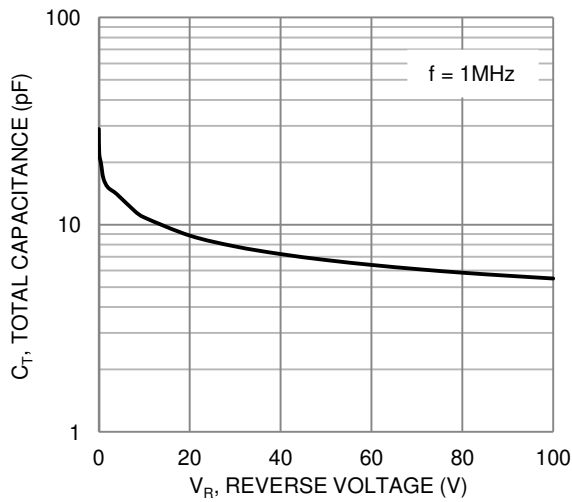
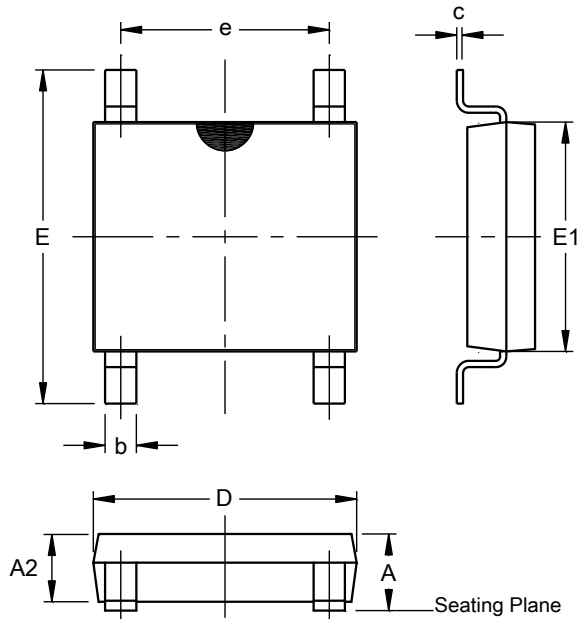


Figure 5. Typical Total Capacitance

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOPA-4 (Type B)

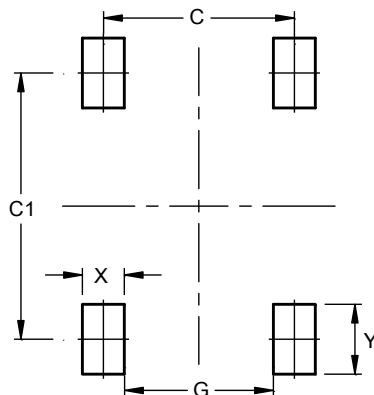


SOPA-4 (Type B)			
Dim	Min	Max	Typ
A	1.15	1.30	--
A2	1.00	1.25	--
b	0.50	0.70	--
c	0.15	0.25	--
D	4.80	5.30	--
E	6.00	6.80	--
E1	4.20	4.60	--
e	3.80	4.20	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOPA-4 (Type B)



Dimensions	Value (in mm)
C	4.10
C1	5.72
G	3.20
X	0.90
Y	1.50

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